

LED SMD



Lead-Free Parts

LG-008WK-DT-L1-P-N12-A03

DATA SHEET

DOC. NO : QW0905-LG-008WK-DT-L1-P-N12-A03

REV. : D

DATE : 09 - Mar. -2011



Features:

1. Side view white LED.
2. white SMT package.
3. Leadframe package with individual 2 pin.
4. Wide viewing angle.
5. Soldering methods: IR reflow soldering.
6. Feature of the device: more light due to higher optical efficiency; extremely wide viewing angle; ideal for backlighting and coupling in light guide.
7. ESD protection.
8. Pb free

Descriptions:

The LG-008 SMD has wide viewing angle, low power consumption and white LEDs are devices which are materialized by combining blue LEDs and special phosphors. This feature makes the LED ideal for light guide application.

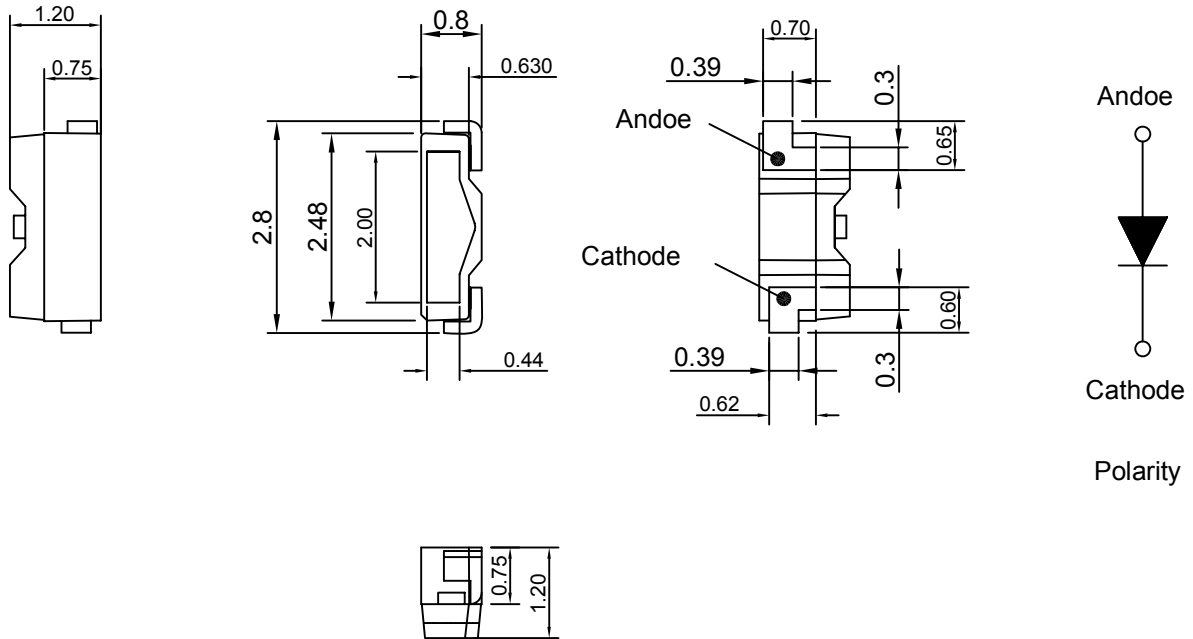
Applications:

1. LCD back light.
2. Mobile phones.
3. Indicators.
4. Switch lights.

Device Selection Guide:

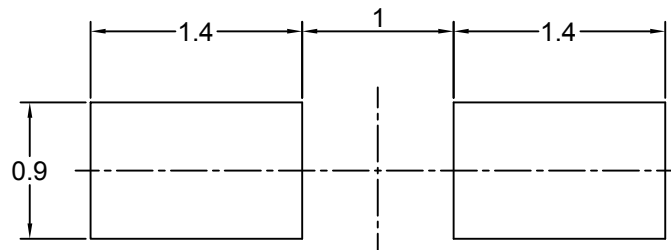
PART NO	MATERIAL	COLOR	
		Emitted	Lens
LG-008WK-DT-L1-P-N12-A03	InGaN/GaN	White	Yellow Diffused

Package Dimensions



Note : 1.All dimension are in millimeter tolerance is $\pm 0.1\text{mm}$ unless otherwise noted.
2.Specifications are subject to change without notice.

Recommended Soldering Pad Dimensions



Note : The tolerances unless mentioned is $\pm 0.1\text{mm}$, Angle ± 0.5 . Unit=mm.

Absolute Maximum Ratings at Ta=25 °C

Parameter	Symbol	Ratings	UNIT
Power Dissipation	PD	80	mW
Peak Forward Current Duty 1/10@10KHz	IFP	100	mA
Forward Current	IF	20	mA
Reverse Current @5V	Ir	50	μA
Electrostatic Discharge	ESD	2000	V
Operating Temperature	Topr	- 40 ~ + 85	°C
Storage Temperature	Tstg	- 40 ~ + 100	°C

Typical Electrical & Optical Characteristics (Ta=25 °C)

Items	Symbol	Min.	Typ.	Max.	UNIT	CONDITION
Luminous Intensity	Iv	1200	1500	----	mcd	IF=20mA
Chromaticity Coordinates	X	0.287	----	0.315	----	IF=20mA
	Y	0.28	----	0.311	----	IF=20mA
Forward Voltage	V _F	2.8	----	3.6	V	IF=20mA
Viewing Angle	2θ 1/2	----	115	----	deg	IF=20mA

Note : 1.The forward voltage data did not including ±0.1V testing tolerance.

2. The luminous intensity data did not including ±10% testing tolerance.

Luminous Intensity Classification (at 20mA)

BIN CODE	Iv(mcd) at20mA		BIN CODE	Iv(mcd) at20mA	
	Min.	Max.		Min.	Max.
W12	1200	1250	W35	1850	1900
W13	1250	1300	W36	1900	1950
W14	1300	1350	W37	1950	2000
W15	1350	1400	X11	2000	2050
W21	1400	1450	X12	2050	2100
W22	1450	1500	X13	2100	2150
W23	1500	1550	X14	2150	2200
W24	1550	1600	X15	2200	2250
W25	1600	1650	X16	2250	2300
W31	1650	1700	X17	2300	2350
W32	1700	1750	X18	2350	2400
W33	1750	1800	X19	2400	2450
W34	1800	1850	X20	2450	2500

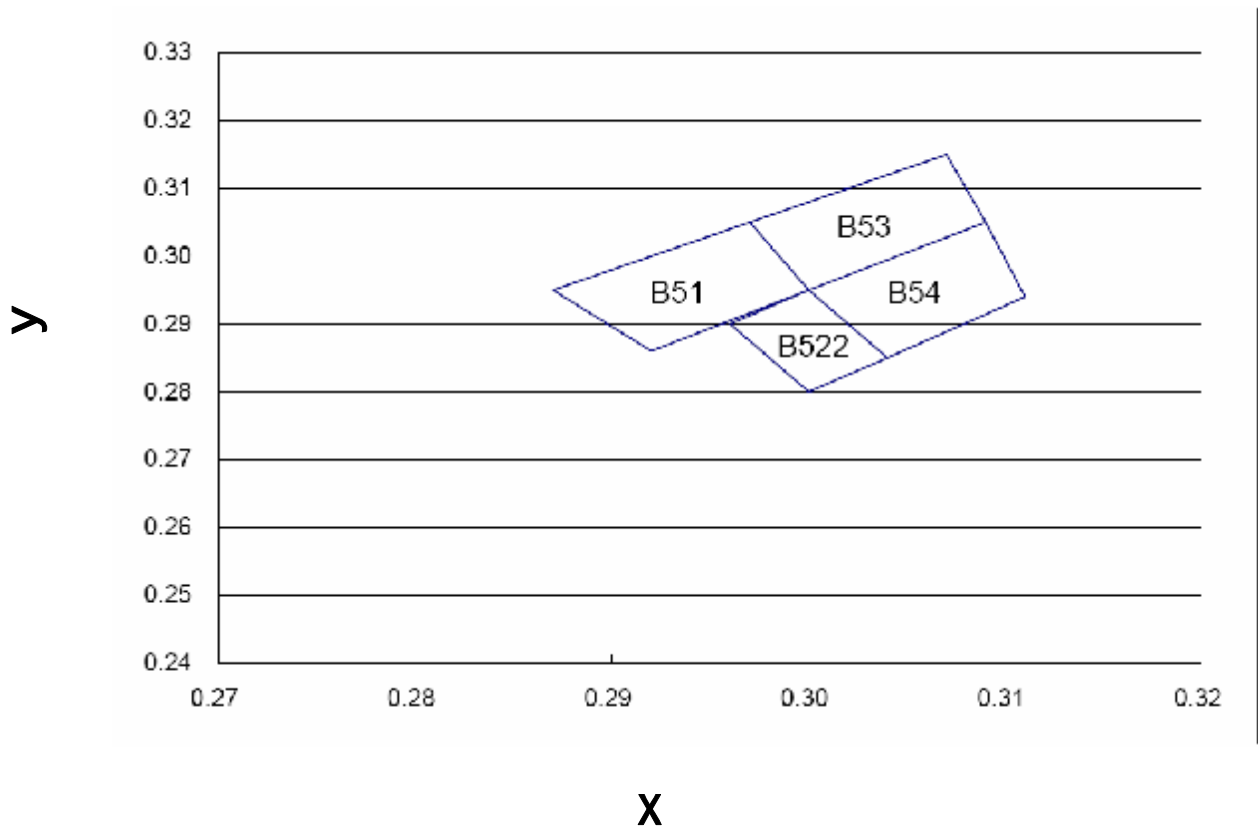
Forward Voltage Classification (at 20mA)

BIN CODE	Vf(v)	
	Min.	Max.
1	2.8	2.9
2	2.9	3.0
3	3.0	3.1
4	3.1	3.2
5	3.2	3.3
6	3.3	3.4
7	3.4	3.5
8	3.5	3.6

Chromaticity Coordinates Specifications For Bin Grading

Color Coordiante at 20mA								
BIN CODE	1		2		3		4	
	X	Y	X	Y	X	Y	X	Y
B51	0.287	0.295	0.292	0.286	0.3	0.295	0.297	0.305
B53	0.297	0.305	0.3	0.295	0.309	0.305	0.307	0.315
B522	0.3	0.28	0.296	0.29	0.304	0.285	0.3	0.295
B54	0.3	0.295	0.304	0.285	0.311	0.294	0.309	0.305

CIE Chromaticity Diagram



Typical Electro-Optical Characteristics Curve

WK CHIP

Fig.1 Forward current vs. Forward Voltage

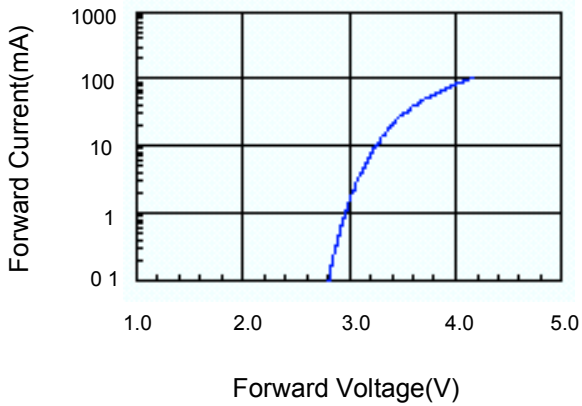


Fig.2 Relative Intensity vs. Forward Current

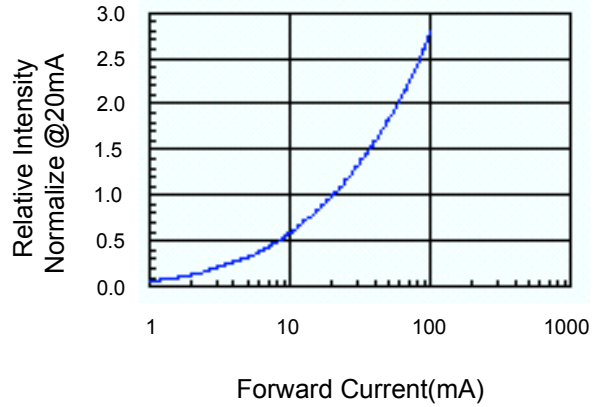


Fig.3 Forward Voltage vs. Temperature

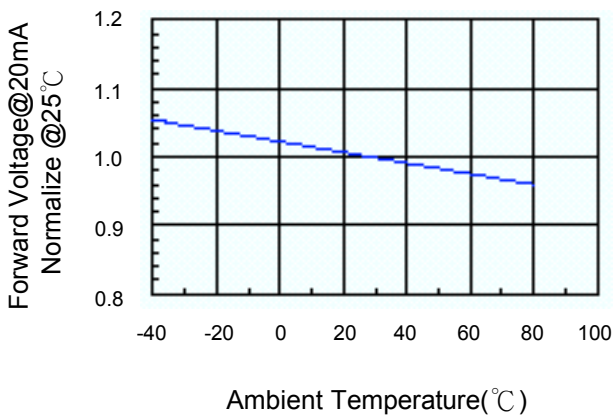


Fig.4 Relative Intensity vs. Temperature

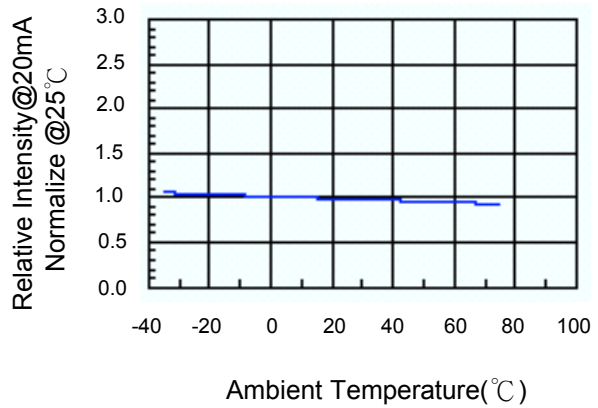
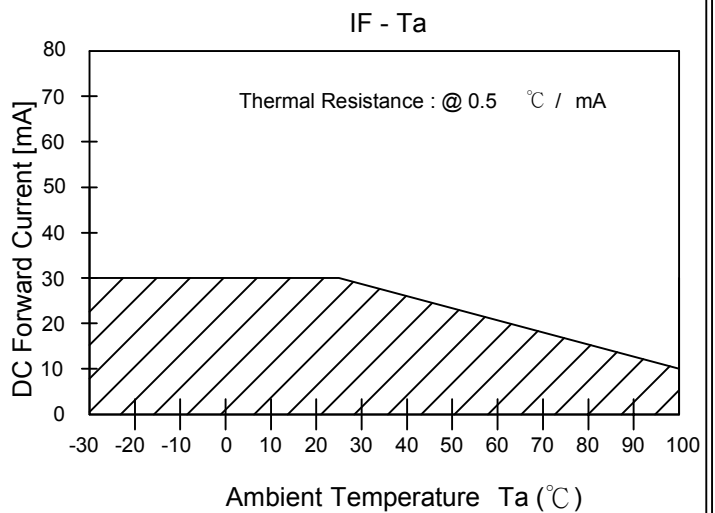
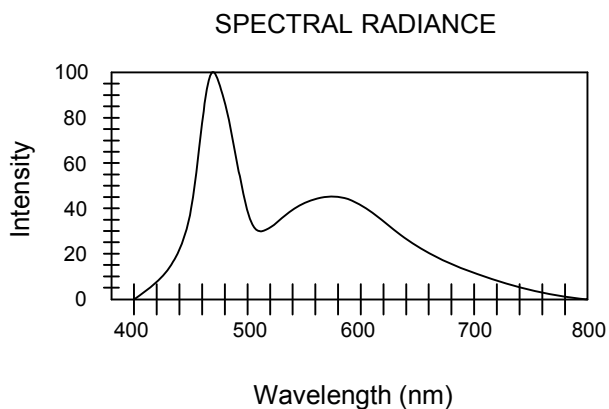
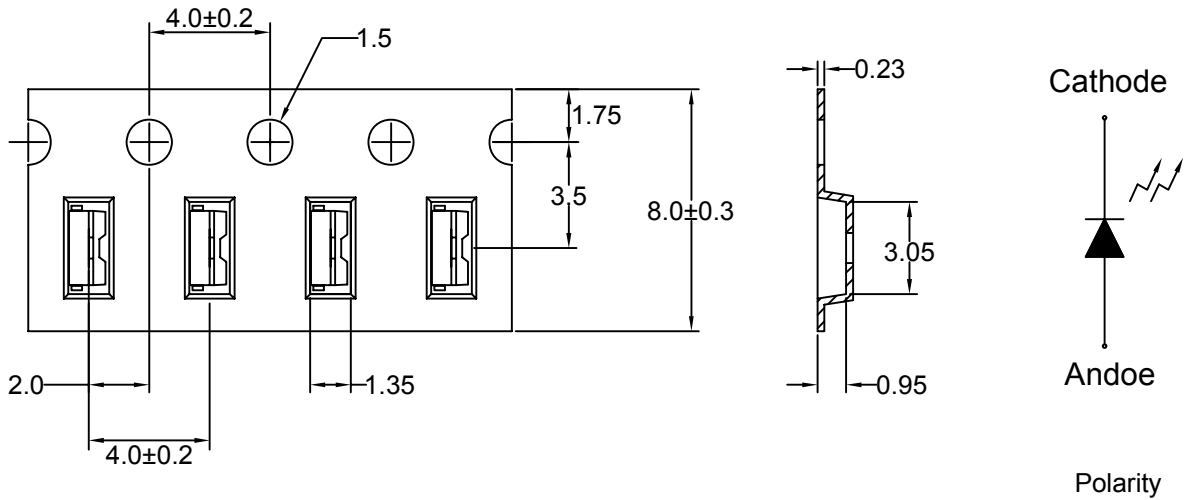


Fig.5 Luminous Spectrum (Ta=25°C)

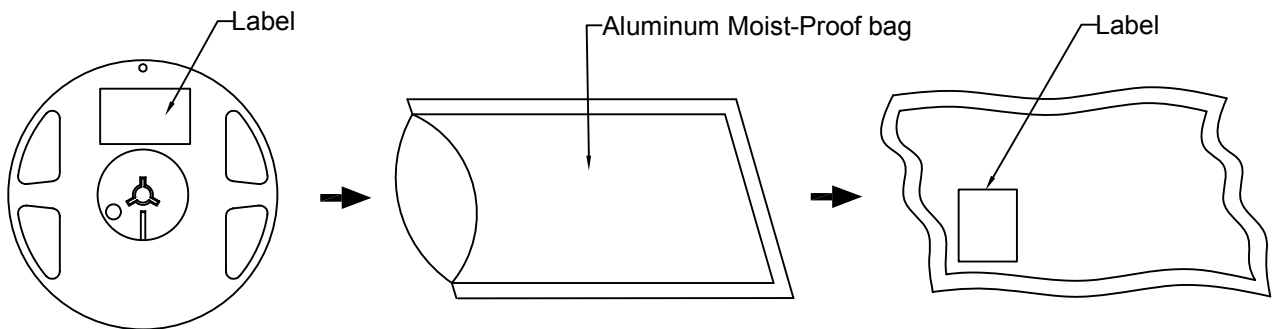


Carrier Type Dimensions









Note : The tolerances unless mentioned is ± 0.1 mm, Angle ± 0.5 . Unit=mm.

• Packing Specifications



Part No.	Description	Quantity/Reel
LG-008WK-DT-L1-P-N12-A03	8.0mm tape, 7" reel	3000 devices

Label Explanation

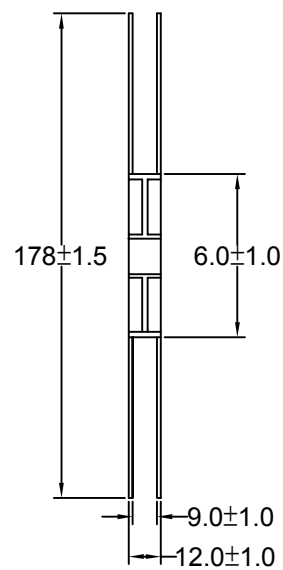
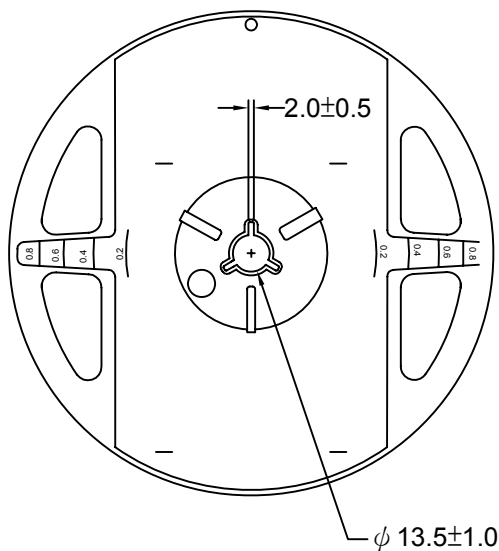
	LIGITEK ELECTRONICS CO., LTD.	
		
	PART :	LG-008WK-DT-L1-P-N12-A03
		
	LOT :	GS1-090168
		
QTY(PCS):	3000	
		
BIN/HUE :	W22/B51	VF:3.1-3.2

BIN : Luminous Intensity

HUE : Chromaticity Coordinates
(CIE_x , CIE_y)

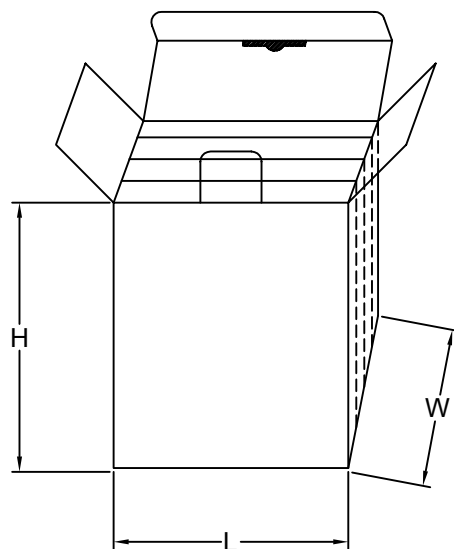
VF : Forward Voltage

Reel Dimensions

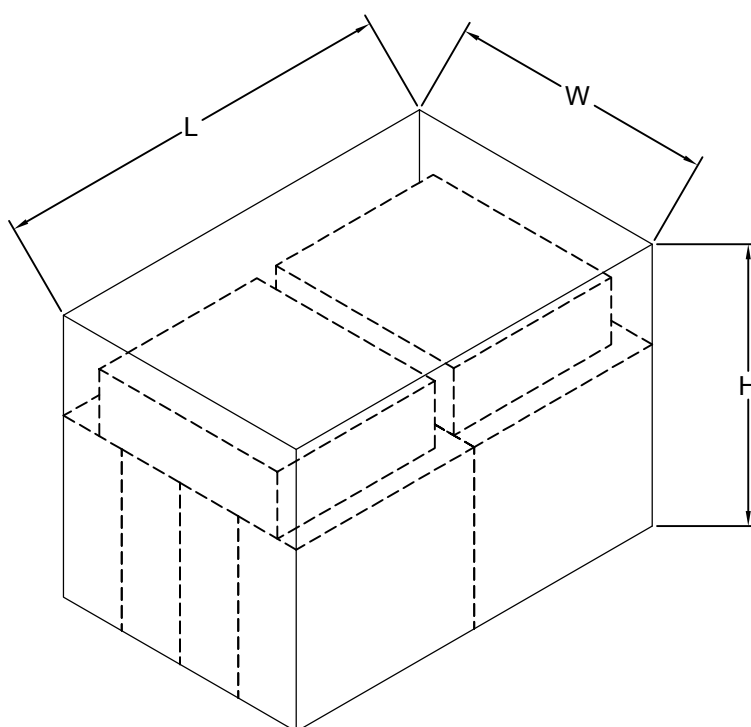


Box Explanation

1. 4 BAG / INNER BOX
2. INNER BOX SIZE : L X W X H 23cm X 8.5cm x 26cm



3. 10 INNER BOXES / CARTON
4. CARTON SIZE : L X W X H 58cm X 34cm x 35cm

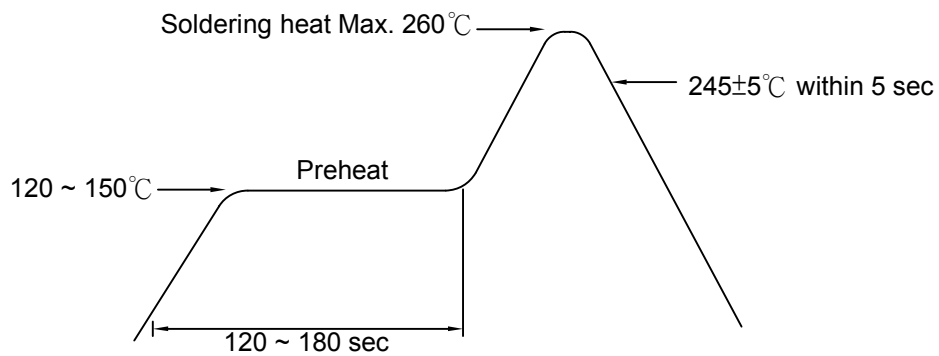


Recommended Soldering Conditions

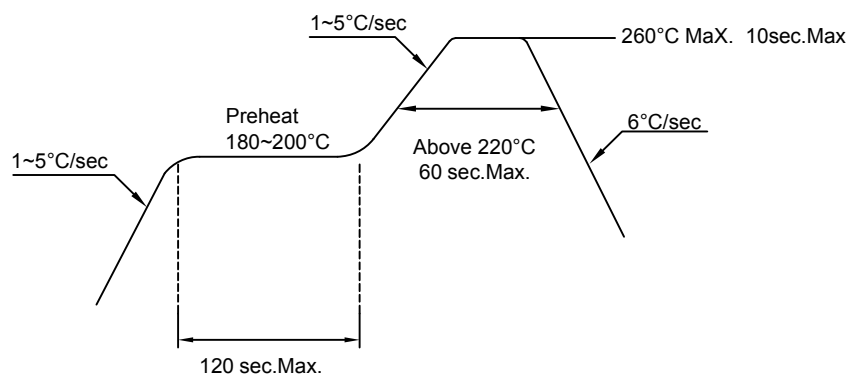
1. Hand Solder

Basic spec is $\leq 320^{\circ}\text{C}$ 3 sec one time only.

2. Wave Solder



3. PB-Free Reflow Solder



Note:

- 1.Reflow soldering should not be done more than two times.
- 2.When soldering,do not put stress on the LEDs during heating.
- 3.After soldering,do not warp the circuit board.

Precautions For Use:**Storage time:**

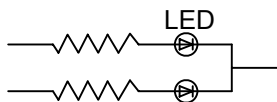
- 1.The operation of Temperatures and RH are : $5^{\circ}\text{C}\sim 35^{\circ}\text{C}$,RH60%.
- 2.Once the package is opened, the products should be used within a week.
Otherwise, they should be kept in a damp proof box with desiccating agent.
Considering the tape life, we suggest our customers to use our products within a year(from production date).
- 3.If opened more than one week in an atmosphere $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$,RH60%, they should be treated at $60^{\circ}\text{C}\pm 5^{\circ}\text{C}$ for 15hrs.

Drive Method:

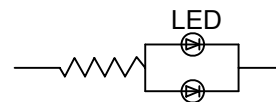
LED is a current operated device, and therefore, requires some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in series with the LED.

Consider worst case voltage variations that could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.

Circuit model A



Circuit model B



(A) Recommended circuit.

(B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

ESD(Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling these LED. All devices, equipment and machinery must be properly grounded.

Reliability Test:

(1) Test items and results

Classification	Test Item	Test Condition	Sample Size
Endurance Test	Operating Life Test	1.Ta=Under Room Temperature As Per Data Sheet Maximum Rating. 2.If=20mA 3.t=1000 hrs	22
	High Temperature Storage Test	1.Ta=105°C±5°C 2.t=1000 hrs	22
	Low Temperature Storage Test	1.Ta=-40°C±5°C 2.t=1000 hrs	22
	High Temperature High Humidity Storage Test	1.IR-Reflow In-Board, 2 Times 2.Ta=60°C±5°C 3.RH=90%~95% 4.t=1000 hrs ± 2hrs	22
Environmental Test	Thermal Shock Test	1.IR-Reflow In-Board,2 times 2.Ta=105°C ±5°C & -40°C±5°C (30min) (30min) 3.total 100 cycles	22
	Reflow Soldering Test	1.T.Sol=260°C±5°C 2.Dwell Time= 10 Sec.Max.	22
	Temperature Cycling	1.105°C ~ 25°C ~ -40°C 30mins 15mins 30mins 2.100 Cyeles	22

(2) Criteria for judging the damage

Item	Symbol	Test Conditions	Criteria for Judgement	
			Min.	Max.
Forward Voltage	Vf	If=20mA	-	U.S.L x1.2
Reverse Current	Ir	Vr=5V	-	U.S.L x2.0
Luminous Intensity	Iv	If=20mA	L.S.L x 0.5	-

Note:

1.U.S.L.:Upper Standard Level.

2.L.S.L.:Lower Standard Level.